April 1999

FDN335N

SEMICONDUCTOR IM

FDN335N N-Channel 2.5V Specified PowerTrench[™] MOSFET

General Description

This N-Channel 2.5V specified MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

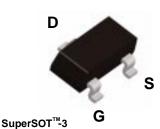
Applications

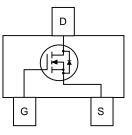
• DC/DC converter

Load switch

Features

- 1.7 A, 20 V. $R_{DS(ON)} = 0.07 \Omega @ V_{GS} = 4.5 V$ $R_{DS(ON)} = 0.100 \Omega @ V_{GS} = 2.5 V.$
- Low gate charge (3.5nC typical).
- High performance trench technology for extremely low R_{DSION}.
- High power and current handling capability.





Absolute Maximum Ratings T_A = 25°C unless otherwise noted Symbol Parameter Units Ratings V_{DSS} **Drain-Source Voltage** 20 V V_{GSS} Gate-Source Voltage <u>+</u>8 V 1.7 I_{D} Drain Current - Continuous А (Note 1a) - Pulsed 8 P_{D} Power Dissipation for Single Operation 0.5 W (Note 1a) (Note 1b) 0.46 TJ, Tsta Operating and Storage Junction Temperature Range -55 to +150 °C **Thermal Characteristics** Thermal Resistance, Junction-to-Ambient (Note 1a) 250 °C/W $R_{\theta JA}$ R_{AJC} Thermal Resistance, Junction-to-Case (Note 1) 75 °C/W Package Outlines and Ordering Information **Device Marking** Device **Reel Size Tape Width** Quantity 335 FDN335N 7" 8mm 3000 units

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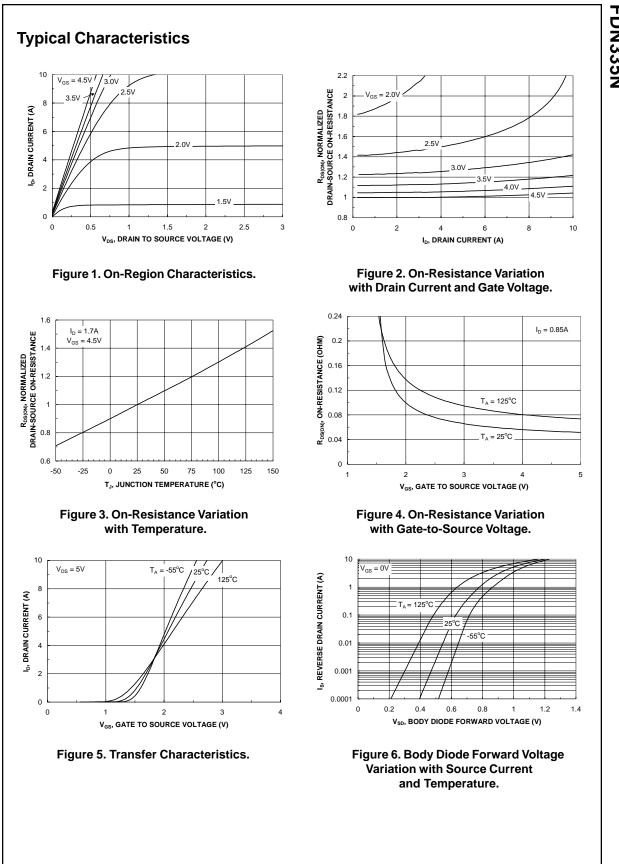
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	20		ĺ	V
<u>Δ</u> BVbss ΔTJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A,Referenced to 25°C		14		mV/∘C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 16 V, V _{GS} = 0 V			1	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 8 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -8 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.4	0.9	1.5	V
$\Delta VGS(th)$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced to 25°C		-3		mV/∘C
R _{DS(ON)}	Static Drain-Source On-Resistance	$ \begin{array}{l} V_{GS} = 4.5 \ V, \ I_D = 1.7 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 1.7 \ A, \\ T_J = 125^{\circ}C \\ V_{GS} = 2.5 \ V, \ I_D = 1.5 \ A \end{array} $		0.055 0.079 0.078	0.070 0.120 0.100	Ω
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	8			Α
g fs	Forward Transconductance	$V_{DS} = 5 V, I_D = 1.5 A$		7		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		310		pF
C _{oss}	Output Capacitance			80		pF
C _{rss}	Reverse Transfer Capacitance			40		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 10 \text{ V}, I_D = 1 \text{ A},$	1	5	15	ns
tr	Turn-On Rise Time	V_{GS} = 4.5 V, R_{GEN} = 6 Ω		8.5	17	ns
t _{d(off)}	Turn-Off Delay Time	-		11	20	ns
t _f	Turn-Off Fall Time	-		3	10	ns
Qg	Total Gate Charge	$V_{DS} = 10 \text{ V}, I_{D} = 1.7 \text{ A},$		3.5	5	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 4.5 V,		0.55		nC
Q _{gd}	Gate-Drain Charge			0.95		nC
Drain-So	urce Diode Characteristics a	and Maximum Ratings				
l _s	Maximum Continuous Drain-Source				0.42	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 0.42 A$ (Note 2)		0.7	1.2	V
surface of the d	sum of the junction-to-case and case-to-ambient rain pins. R_{BUC} is guaranteed by design while R_{BCA} is a 250°C/W when P b) 2		erence is o	defined as t	he solder m	ounting

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mounted on a 0.02 in² Pad of 2 oz. Cu. Scale 1 : 1 on letter size paper

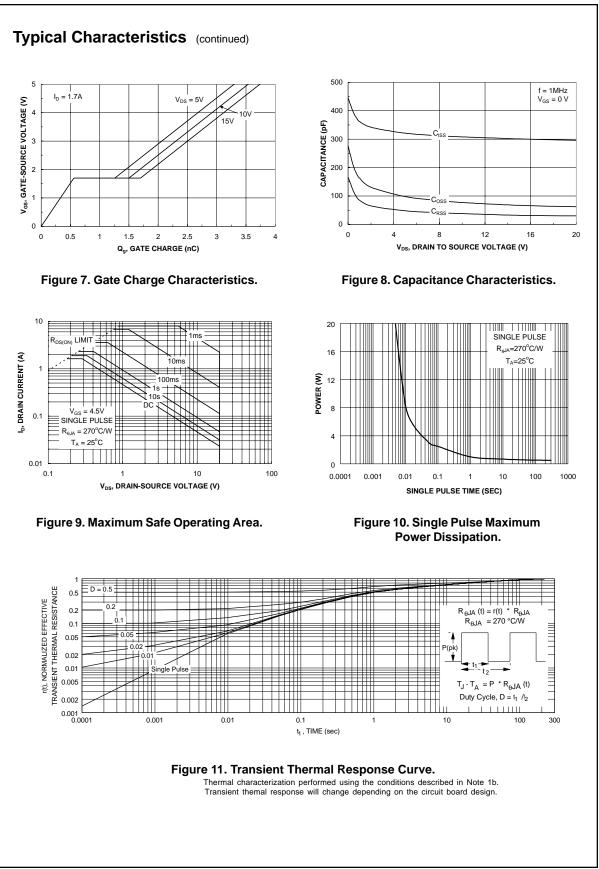
2: Pulse Test: Pulse Width $\leq 300~\mu\text{s},~\text{Duty}~\text{Cycle} \leq 2.0\%$

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FDN335N Rev. C

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